

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Masaya OKADA	03/22/2011
Makoto KIYAMA	03/22/2011
Seiji YAEGASHI	03/24/2011
Ken NAKATA	03/31/2011

RECEIVING PARTY DATA

Name:	Sumitomo Electric Industries, Ltd.
Street Address:	5-33, Kitahama 4-chome, Chuo-ku
City:	Osaka-shi, Osaka
State/Country:	JAPAN
Postal Code:	541-0041

Name:	Sumitomo Electric Device Innovations, Inc.
Street Address:	1, Kanai-cho, Sakae-ku
City:	Yokohama-shi, Kanagawa
State/Country:	JAPAN
Postal Code:	244-0845

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13126569

CORRESPONDENCE DATA

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**PATENT
 REEL: 026194 FRAME: 0147**

Address Line 4: WASHINGTON, DISTRICT OF COLUMBIA 20043-9998

ATTORNEY DOCKET NUMBER:

40616-302915

NAME OF SUBMITTER:

Michael A. Sartori, Ph.D.

Total Attachments: 4

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ASSIGNMENT BY INVENTOR

THIS ASSIGNMENT, made by Masaya OKADA and Makoto KIYAMA (hereinafter referred to as Assignor), residing at c/o Osaka Works of Sumitomo Electric Industries, Ltd., 1-3, Shimaya 1-chome, Konohana-ku, Osaka-shi, Osaka, JAPAN and Seiji YAEGASHI and Ken NAKATA(hereinafter referred to as Assignor), residing at c/o Yokohama Works of Sumitomo Electric Industries, Ltd., 1, Taya-cho, Sakae-ku, Yokohama-shi, Kanagawa, JAPAN;

WHEREAS, Assignor has invented certain new and useful improvements in SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING SAME, set forth in a patent application for Letters Patent of the United States,

executed concurrently herewith;

filed on _____ as U.S. Patent Application No. _____; and

WHEREAS, SUMITOMO ELECTRIC INDUSTRIES, LTD. having its principal place of business at 5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi, Osaka 541-0041, JAPAN and SUMITOMO ELECTRIC DEVICE INNOVATIONS, INC. having its principal place of business at 1, Kanai-cho, Sakae-ku, Yokohama-shi, Kanagawa 244-0845, JAPAN (hereinafter both referred to as Assignee), are desirous of acquiring the entire right, title and interest in and to said inventions and said Application for Letters Patent of the United States, and in and to any Letters Patent of the United States to be obtained therefore and thereon.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and sufficient consideration, the receipt of which is hereby acknowledged, Assignor has sold, assigned, transferred and set over, and by these presents does sell, assign, transfer and set over, unto Assignee, its successors, legal representatives and assigns, the entire right, title and interest in and to the above-mentioned inventions and application for Letters Patent, and in and to any and all direct and indirect divisions, continuations and continuations-in-part of said

application, and any and all Letters Patent in the United States which may be granted therefore and thereon, and reissues, reexaminations and extensions of said Letters Patent, and all rights under the International Convention for the Protection of Industrial Property, the same to be held and enjoyed by Assignee, for its own use and benefit and the use and benefit of its successors, legal representatives and assigns, to the full end of the term or terms for which Letters Patent may be granted and/or extended, as fully and entirely as the same would have been held and enjoyed by Assignor, had this sale and assignment not been made.

AND for the same consideration, Assignor hereby represents and warrants to Assignee, its successors, legal representatives and assigns, that, at the time of execution and delivery of these presents, except for any rights, titles and/or interests that have arisen to Assignee under law or that have already been transferred to Assignee, Assignor is the sole and lawful owners of the entire right, title and interest in and to the said inventions and application for Letters Patent above-mentioned, and that the same are unencumbered and that Assignor has good and full right and lawful authority to sell and convey the same in the manner herein set forth.

AND for the same consideration, Assignor hereby covenants and agrees to and with Assignee, its successors, legal representatives and assigns, that Assignor will sign all papers and documents, take all lawful oaths and do all acts necessary or required to be done for the procurement, maintenance, enforcement and defense of any Letters Patent and applications for Letters Patent for said inventions, without charge to Assignee, its successors, legal representatives and assigns, whenever counsel of Assignee, or counsel of its successors, legal representatives and assigns, shall advise: that any proceeding in connection with said inventions, or said Patent application for Letters Patent, or any proceeding in connection with any Letters Patent or applications for Letters Patent for said inventions including but not limited to interference proceedings, is lawful and desirable; or, that any division, continuation or continuation-in-part of any application for Letters Patent, or any reissue, reexamination or extension of any Letters Patent, to be obtained thereon, is lawful and desirable.

AND Assignor hereby requests the Commissioner of Patent and Trademarks to issue said Letters Patent of the United States to Assignee, as Assignee of said inventions and the Letters Patent to be issued thereon, for the sole use and benefit of Assignee, its successors, legal representatives and assigns.

Executed on:

March 24, 2011
Date

Assignor:
Seiji YAEGASHI
Assignor Name

Seiji Yaegashi
Signature

Witness:

Witness Name

Signature

Witness Address

Executed on:

March 31, 2011
Date

Assignor:
Ken NAKATA
Assignor Name

Ken Nakata
Signature

Witness:

Witness Name

Signature

Witness Address